

»Features

- 60Watts peak pulse power ($t_p = 8/20\mu s$)
- Tiny DFN1006 package
- Bidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Low capacitance ($C_j=0.4\text{pF}$ typ. IO to IO)
- Protection one data/power line
- IEC 61000-4-2 $\pm 20\text{kV}$ contact $\pm 20\text{kV}$ air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 3.5A (8/20 μs)



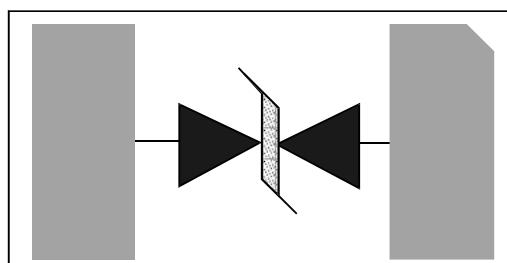
»Applications

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation

»Mechanical Data

- DFN1006 package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

»Schematic & PIN Configuration



DFN1006

»Absolute Maximum Rating

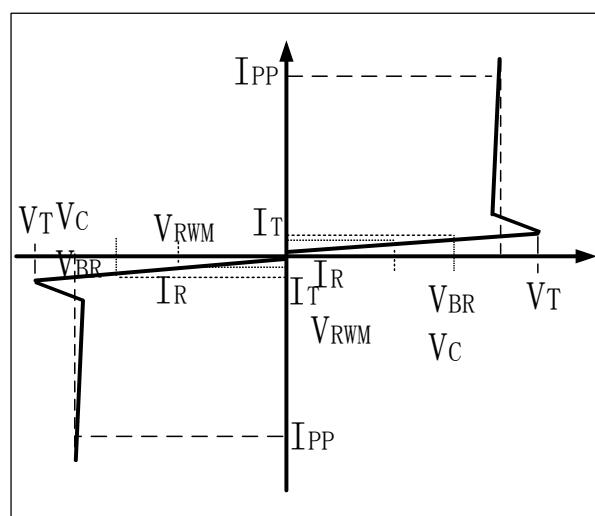
Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P _{PP}	60	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)(note1)	I _{pp}	3.5	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	20 20	kV
Lead Soldering Temperature	T _L	260(10seconds)	°C
Junction Temperature	T _J	-55 to + 125	°C
Storage Temperature	T _{stg}	-55 to + 125	°C

»Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V _{RWM}				3.3	V
Reverse Breakdown Voltage	V _{BR}	I _T =1mA	5.0	7.5		V
Reverse Leakage Current	I _R	V _{RWM} =5V,T=25°C		0.1	0.5	µA
Peak Pulse Current	I _{PP}	t _p =8/20µs			3.5	A
Clamping Voltage	V _C	I _{PP} =1.0A,t _p =8/20µs		8		V
Clamping Voltage	V _C	I _{PP} =3.5A,t _p =8/20µs		15	19	V
Junction Capacitance	C _j	IO to IO V _R = 0V, f = 1MHz		0.4	0.5	pF

»Electrical Parameters (TA = 25°C unless otherwise noted)

Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
V _C	Clamping Voltage @ I _{PP}
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V _{BR}	Breakdown Voltage @ I _T
I _T	Test Current



Note: 8/20µs pulse waveform.

»Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

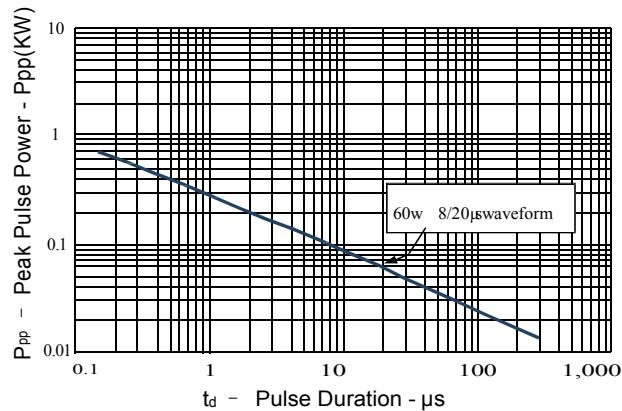


Figure 2: Power Derating Curve

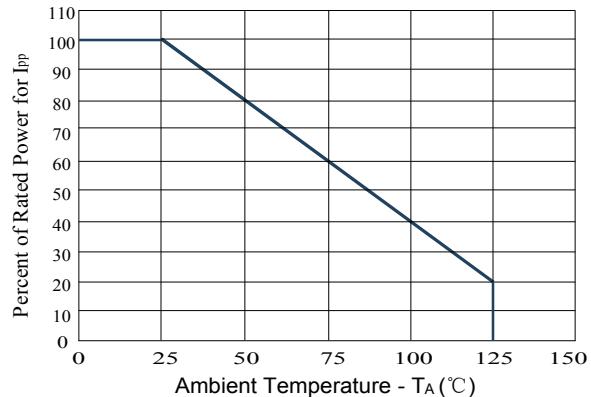


Figure3: Pulse Waveform

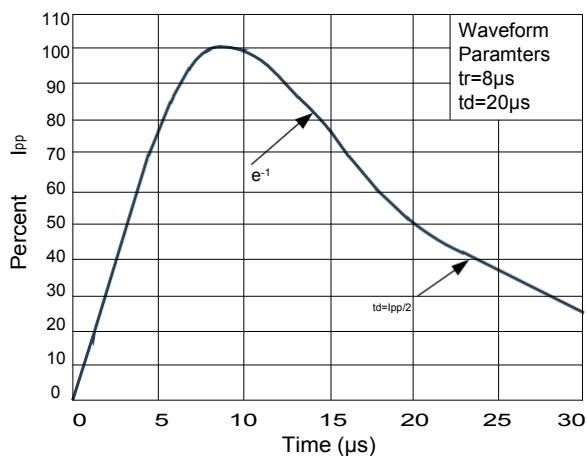


Figure5: Positive Clamping voltage (TLP)

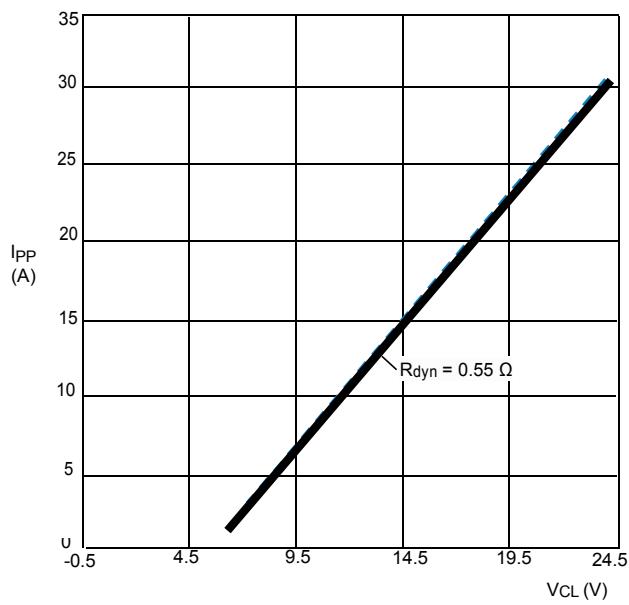


Figure 4: Clamping Voltage vs.Ipp

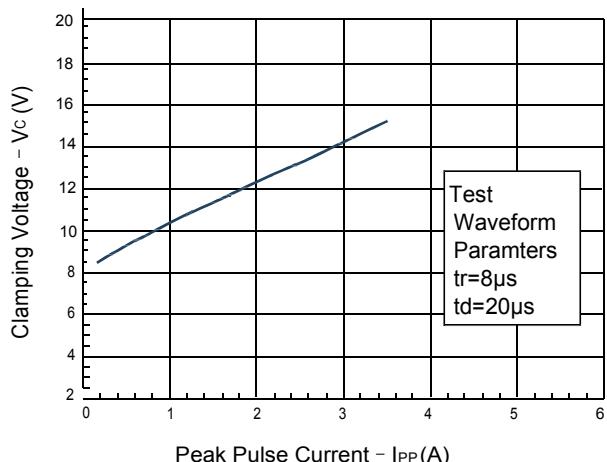
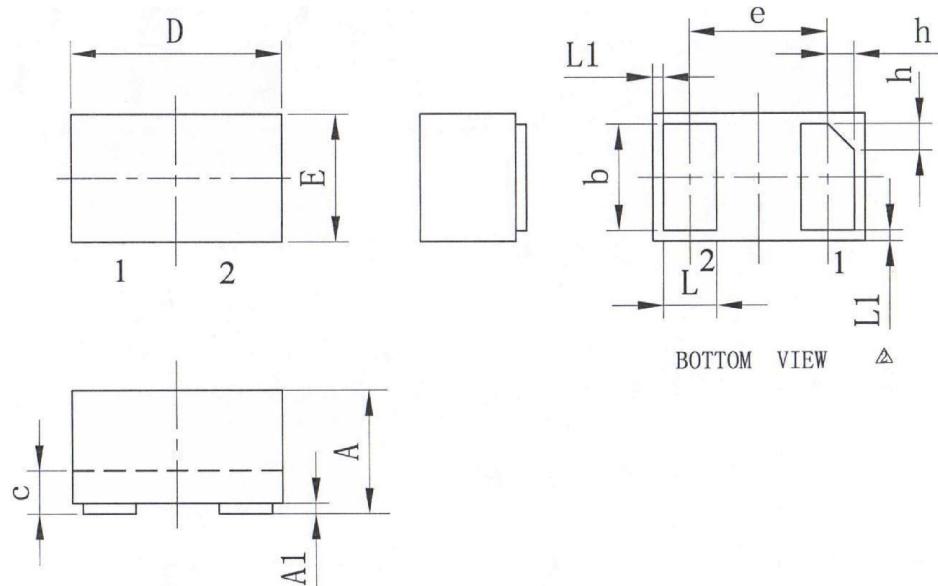


Figure5: Negative Clamping voltage (TLP)

»Outline Drawing – DFN1006



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.45	0.50	0.55
A1	0	0.02	0.05
b	0.45	0.50	0.55
c	0.12	0.15	0.18
D	0.95	1.00	1.05
e	0.65BSC		
E	0.55	0.60	0.65
L	0.20	0.25	0.30
L1	0.05REF		
h	0.07	0.12	0.17
载体尺寸 (Mil)	20*20		

»Marking



»Ordering information

Order code	Package	Base qty	Delivery mode
RCLAMP3321P-N	DFN1006	10k	Tape and reel